

A 167-processor Computational Array for Highly-Efficient DSP and Embedded Application Processing

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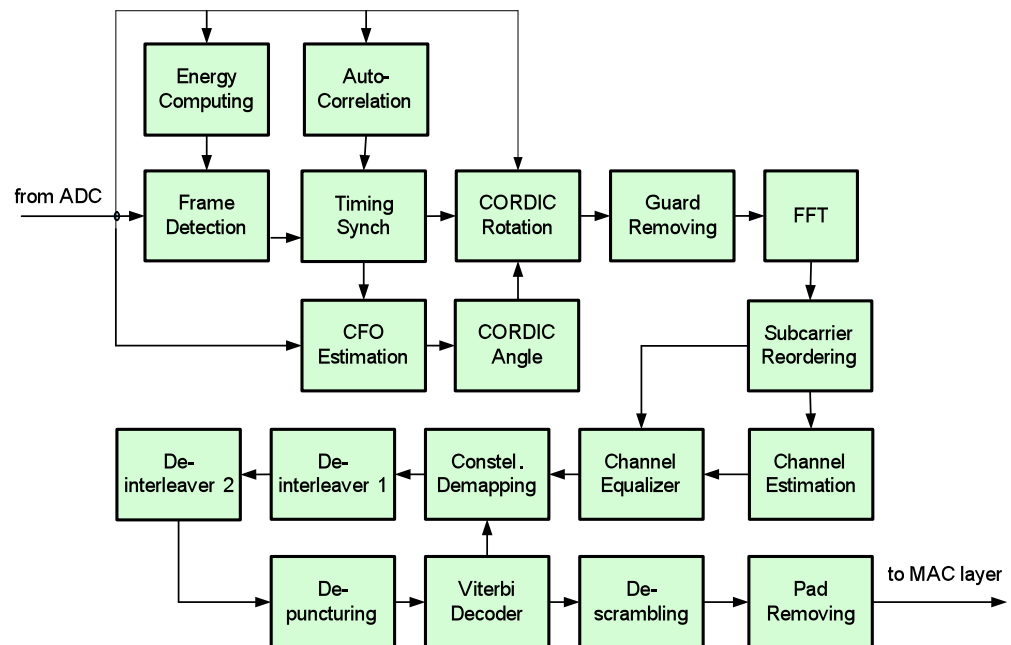
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Outline

- **Goals and Key Ideas**
- **The Second Generation AsAP**
 - Processors and Shared Memories
 - On-chip Communication
 - Dynamic Voltage & Clock Frequency
- **Analysis and Summary**

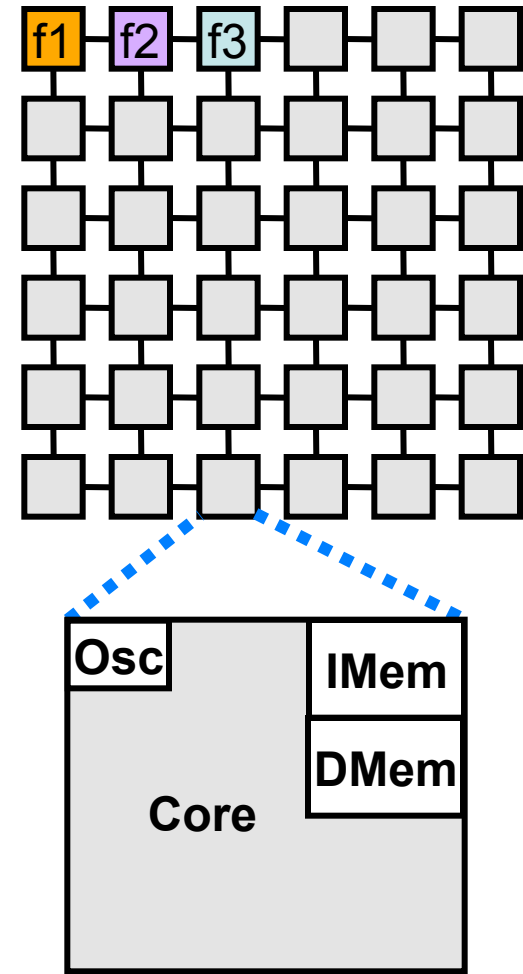
Project Goals

- Fully programmable and reconfig. architecture
- High energy efficiency and performance
- Exploit task-level parallelism in:
 - Digital Signal Processing
 - Multimedia
- Example: 802.11a Wi-Fi baseband receiver



Asynchronous Array of Simple Processors (AsAP)

- Key Ideas:
 - Programmable, small, and simple fine-grained cores
 - Small local memories sufficient for DSP kernels
 - Globally Asynchronous and Locally Synchronous (GALS) clocking
 - Independent clock frequencies on every core
 - Local oscillator halts when processor is idle



Asynchronous Array of Simple Processors (AsAP)

- Key Ideas, con't:
 - 2D mesh, circuit-switched network architecture
 - High throughput of one word per clock cycle
 - Low area overhead
 - Easily scalable array
 - Increased tolerance to process variations
- 36-processor fully-functional chip, 0.18 μm , 610 MHz @ 2.0 V, 0.66 mm^2 per processor [HotChips 06, ISSCC 06, TVLSI 07, JSSC 08,...]

Outline

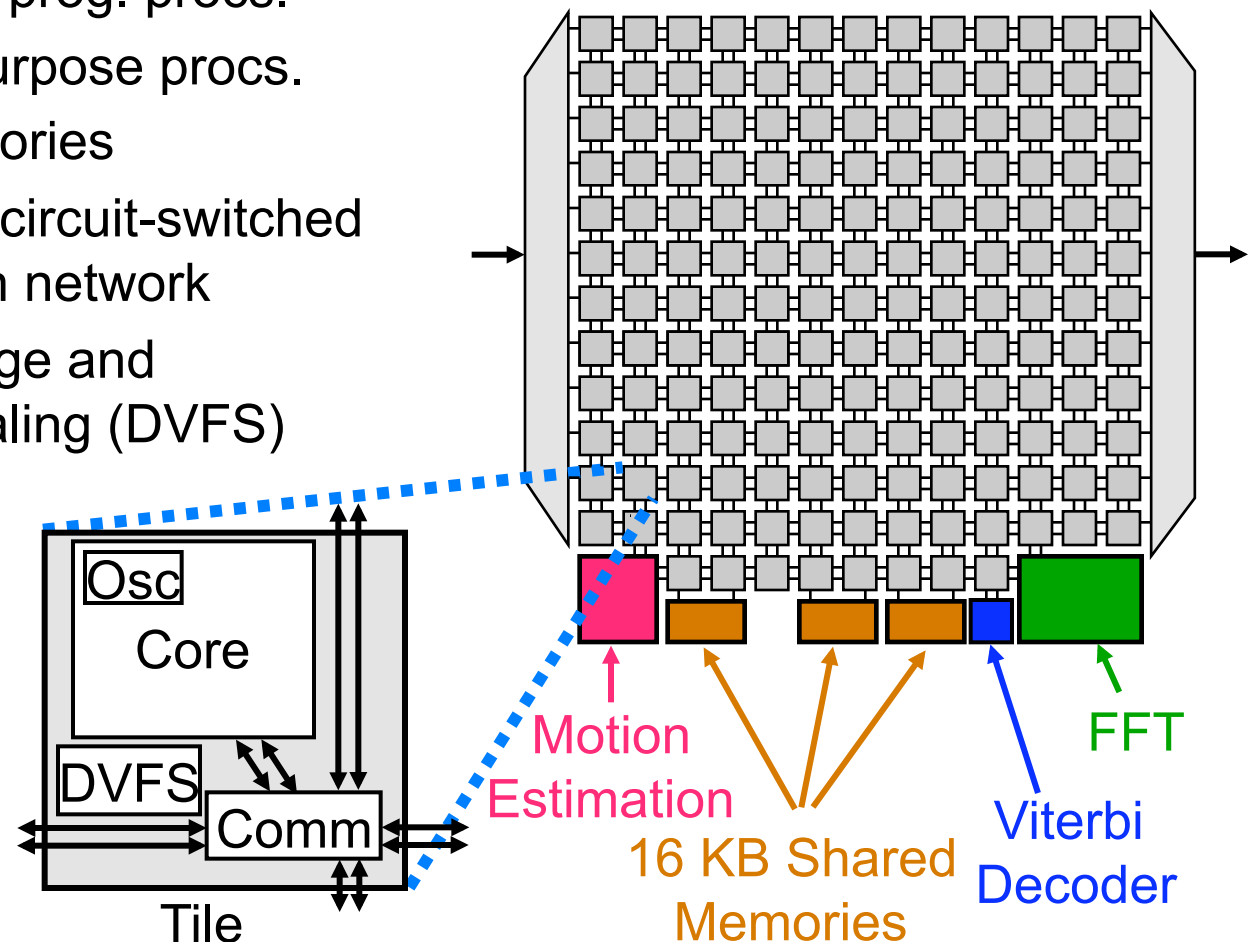
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New Challenges Addressed

1. Reduction in the power dissipation of
 - Lightly-loaded processors (lowering V_{dd})
 - Unused processors (leakage)
2. Achieving very high efficiencies and speed on common demanding tasks such as FFTs, video motion estimation, and Viterbi decoding
3. Larger, area efficient on-chip memories
4. Efficient, low overhead communication between distant processors

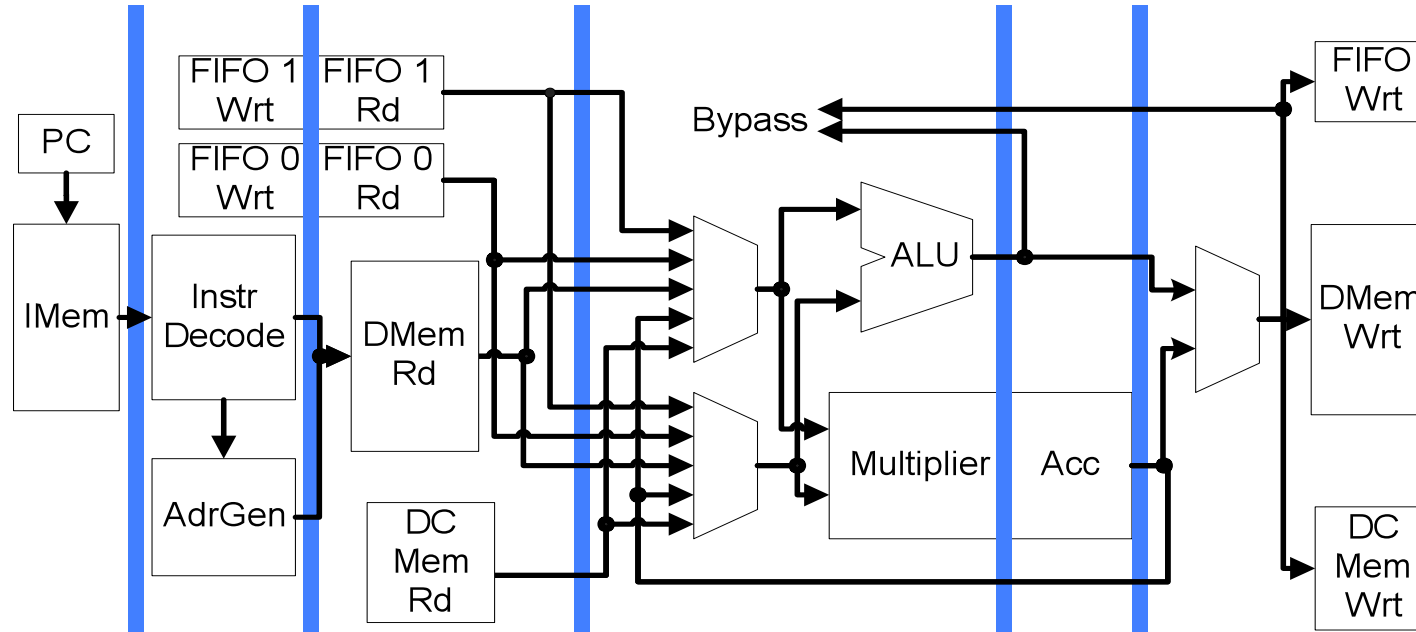
167-processor Computational Platform

- Key features
 - 164 Enhanced prog. procs.
 - 3 Dedicated-purpose procs.
 - 3 Shared memories
 - Long-distance circuit-switched communication network
 - Dynamic Voltage and Frequency Scaling (DVFS)



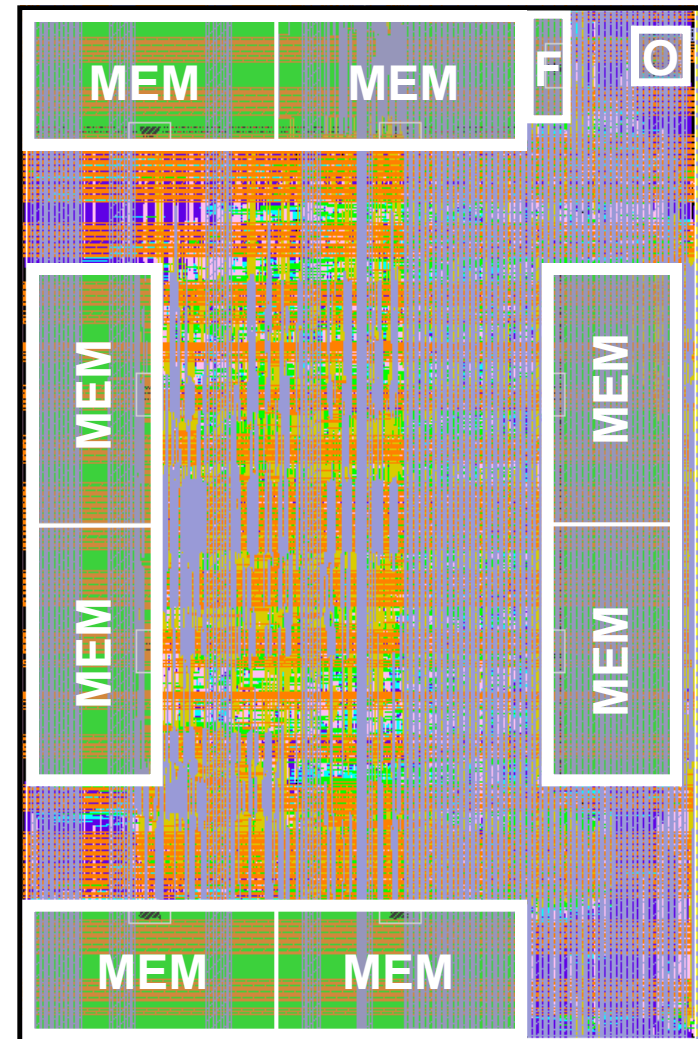
Homogenous Processors

- In-order, single-issue, 6-stage processors
 - 16-bit datapath with MAC and 40-bit accumulator
 - 128x16-bit data memory
 - 128x35-bit instruction memory
 - Two 64x16-bit FIFOs for inter-processor communication
 - Over 60 basic instructions and features geared for DSP and multimedia workloads



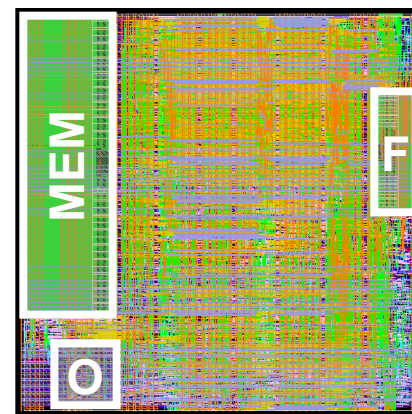
Fast Fourier Transform (FFT)

- Uses
 - OFDM modulation
 - Spectral analysis, synthesis
- Runtime configurable from 16-pt to 4096-pt transforms, FFT and IFFT
- 1.01 mm²
- Preliminary measurements functional at 866 MHz, 34.97 mW @ 1.3 V
 - 681 M complex Sample/s with 1024-pt complex FFTs



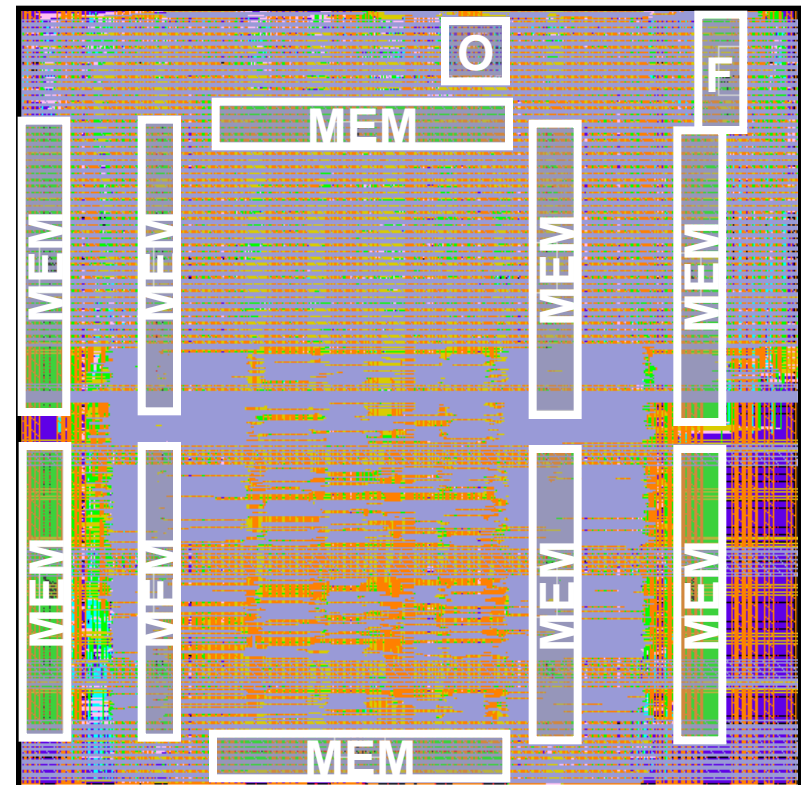
Viterbi Decoder

- Uses
 - Fundamental communications function (wired, wireless, etc.)
 - Storage apps; e.g., hard drives
- Decodes configurable codes up to constraint length 10 with up to 32 different rates
- 0.17 mm²
- Preliminary measurements functional at 894 MHz, 17.55 mW @ 1.3 V
 - 82 Mbps at rate=1/2



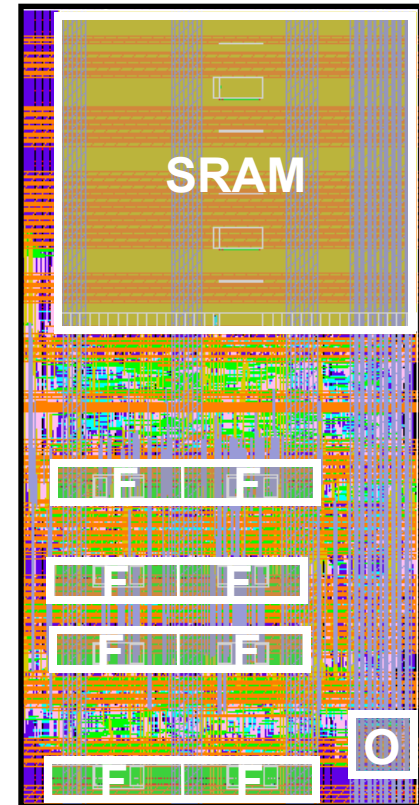
Motion Estimation for Video Encoding

- Uses
 - H.264, MPEG-2, etc. encoders
- Supports a number of fixed and programmable search patterns including all H.264 specified block sizes within a 48x48 search range
- 0.67 mm²
- Preliminary measurements functional at 938 MHz,
196.17 mW @ 1.3 V
 - 15 billion SADs/sec
 - Supports 1080p HDTV @ 30fps



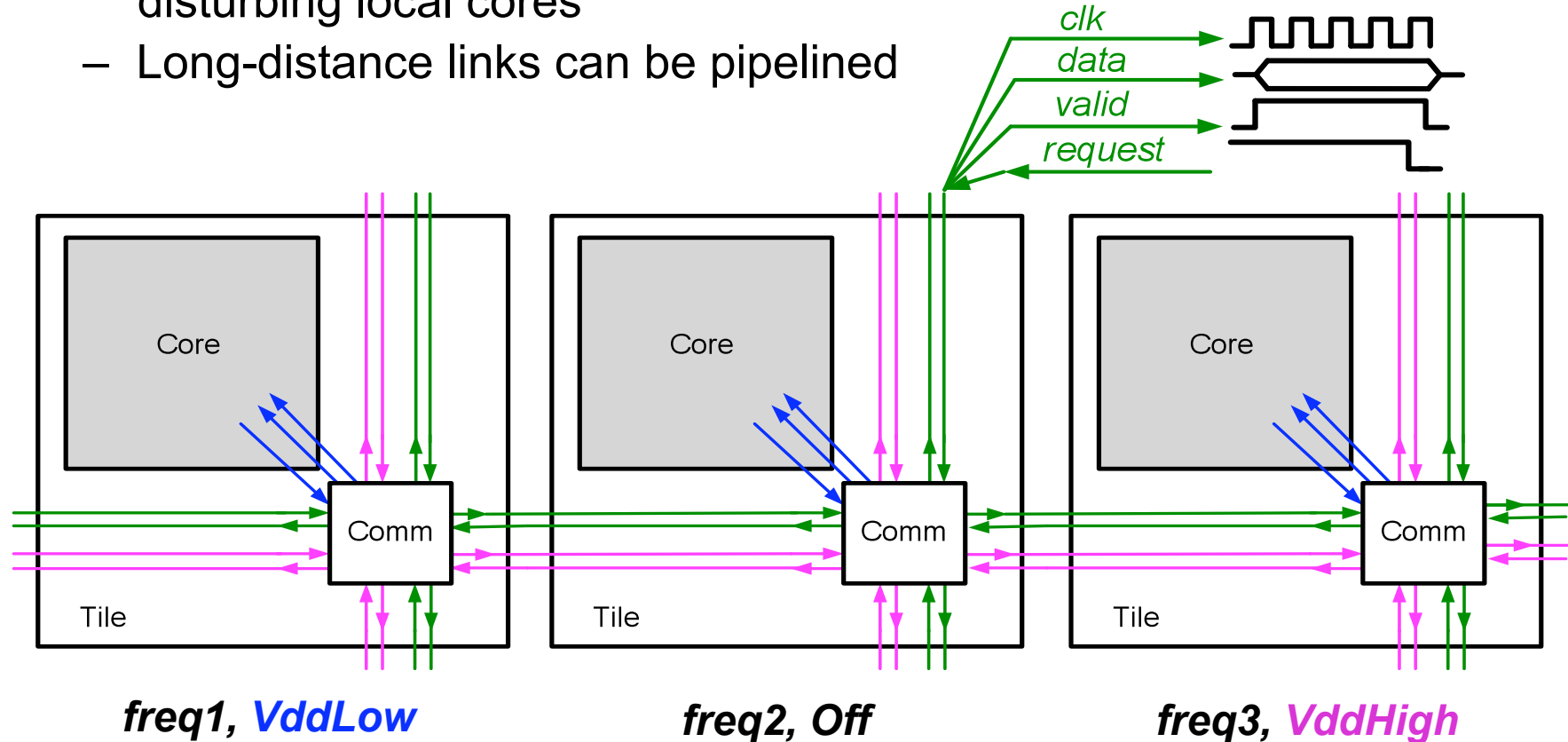
Shared Memories

- Ports for up to four processors (two connected in this chip) to directly connect to the memory block
 - Port priority
 - Port request arbitration
 - Programmable address generation supporting multiple addressing modes
 - Uses a 16 KByte single-ported SRAM
 - One read or write per cycle
- 0.34 mm²
- Preliminary measurements functional at 1.3 GHz, 4.55 mW @ 1.3 V
 - 20.8 Gbps peak throughput



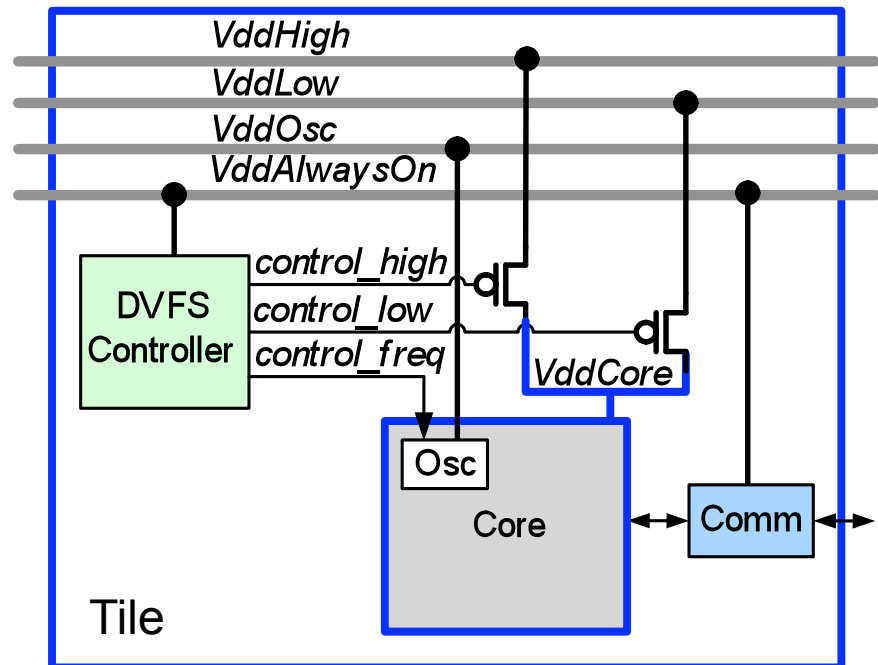
Inter-Processor Communication

- Circuit-switched source-synchronous comm.
 - 8 software controlled outputs and 2 configurable circuit-switched inputs (out of 8 total possible inputs)
 - Long-distance communication can occur across tiles without disturbing local cores
 - Long-distance links can be pipelined



Per-Processor Dynamic Voltage & Clock Frequency

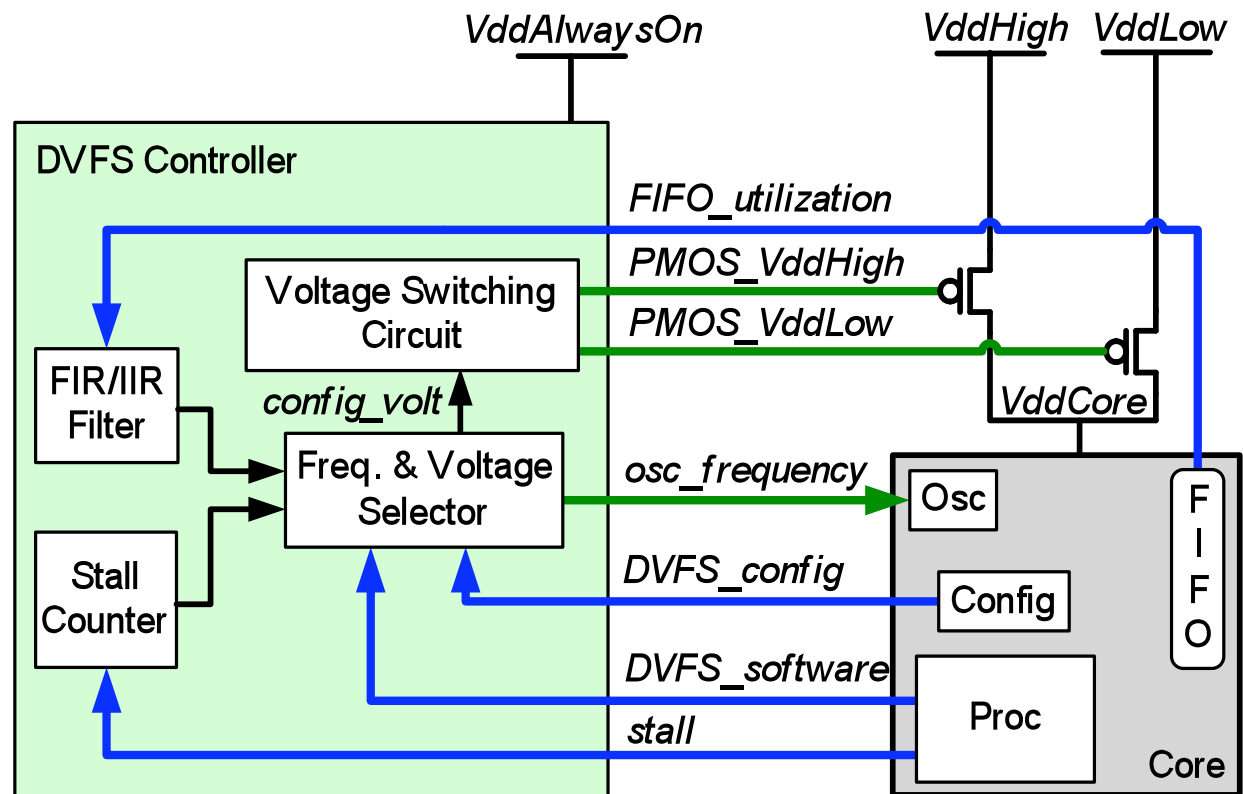
- Each processor tile contains a core that operates at:
 - A fully-independent clock frequency
 - Any frequency below maximum
 - Halts, restarts, and changes arbitrarily
 - Dynamically-changeable supply voltage
 - *VddHigh* or *VddLow*
 - Disconnected for leakage reduction
 - Each power gate comprises 48 individually-controllable parallel transistors
- *VddAlwaysOn* powers DVFS and inter-processor comm.



Dynamic Voltage & Frequency Controller

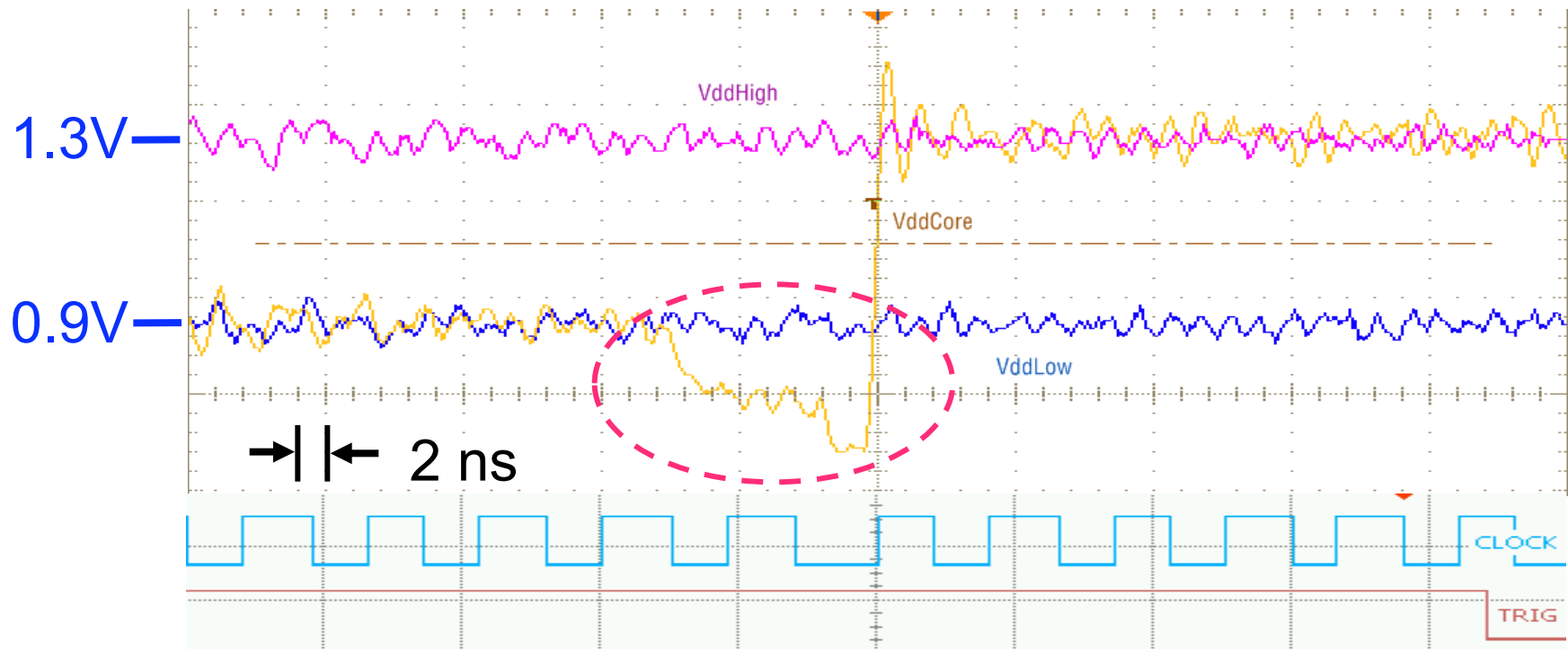
- Voltage and frequency are set by:
 - Static configuration
 - Software
 - Hardware (controller)

- FIFO “fullness”
- Processor “stalling frequency”



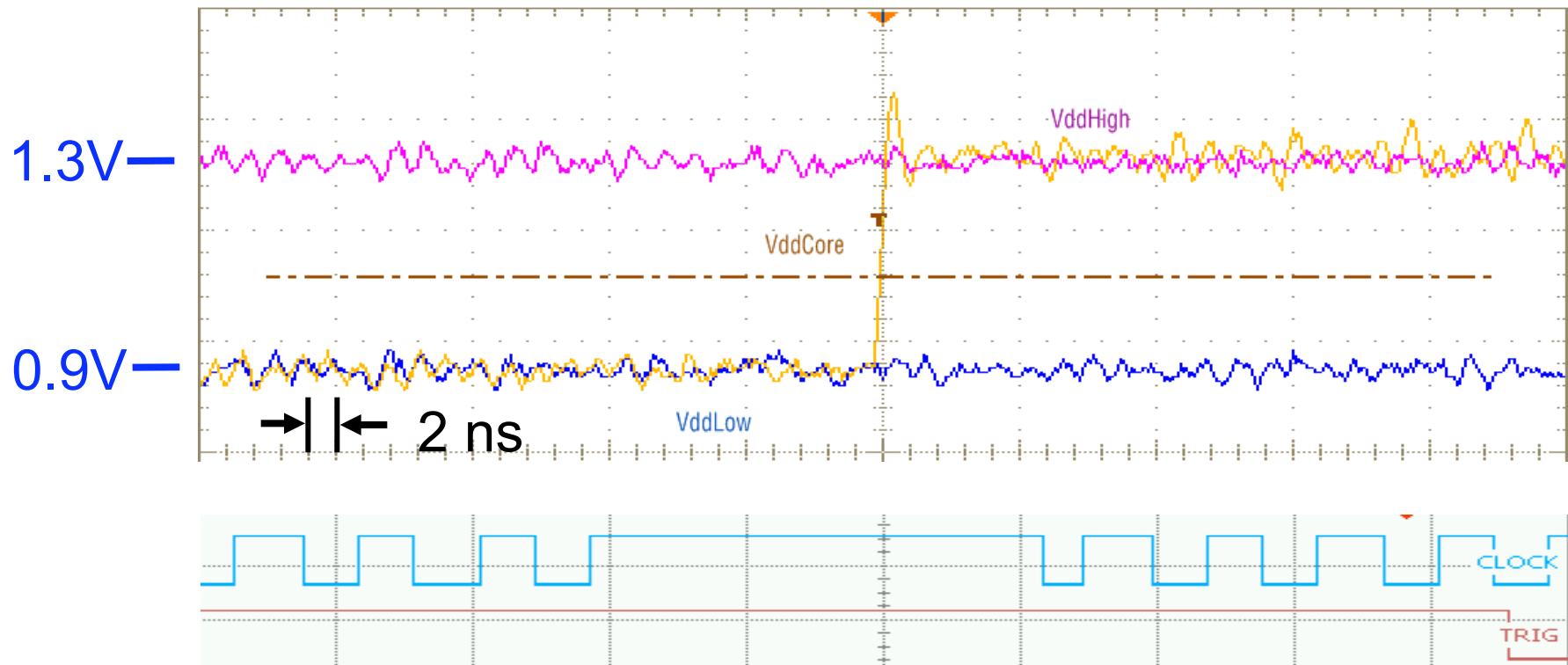
Measured Supply Voltage Switching

- Slow switching results in negligible power grid noise
- Early **VddCore** disconnect from **VddLow** with oscillator running results in a momentary **VddCore** voltage droop (circled below)



Measured Supply Voltage Switching

- Oscillator halting while **VddCore** disconnects from **VddLow** and connects to **VddHigh** results in a negligible voltage droop due to leakage

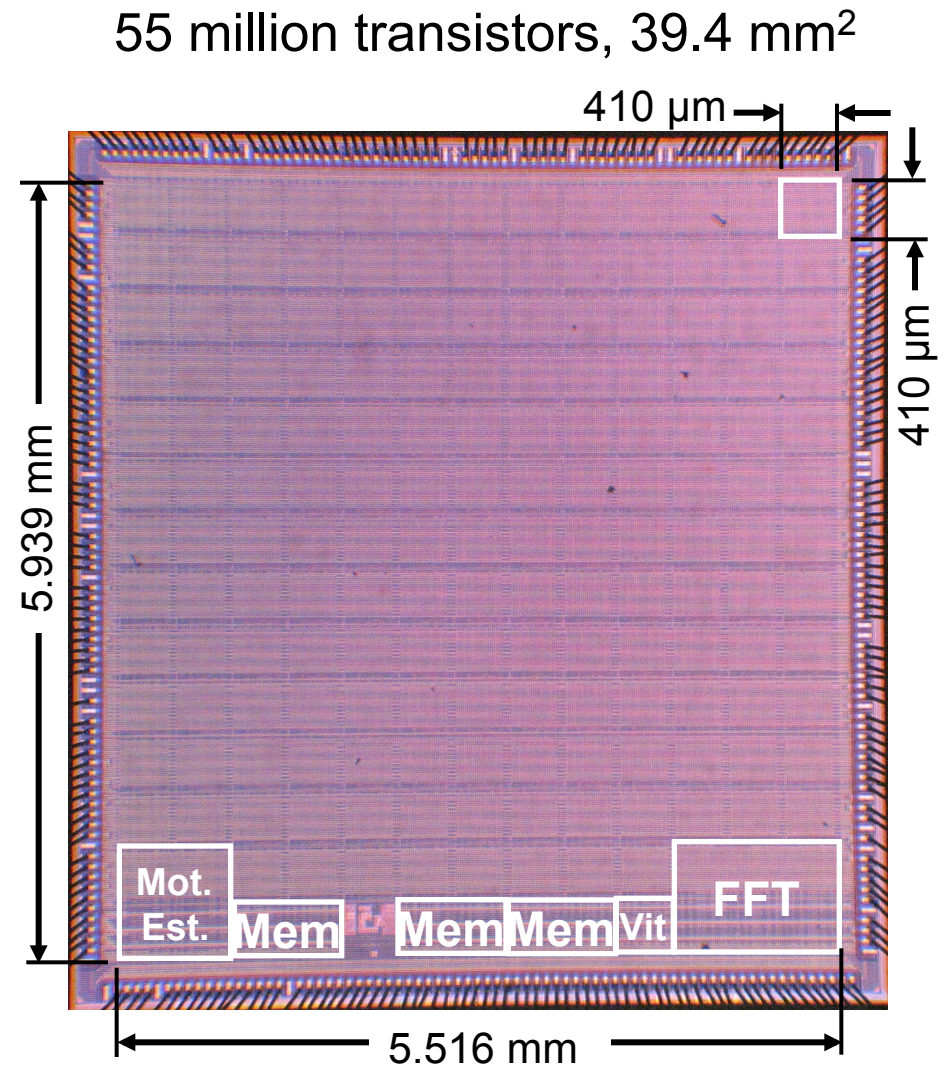


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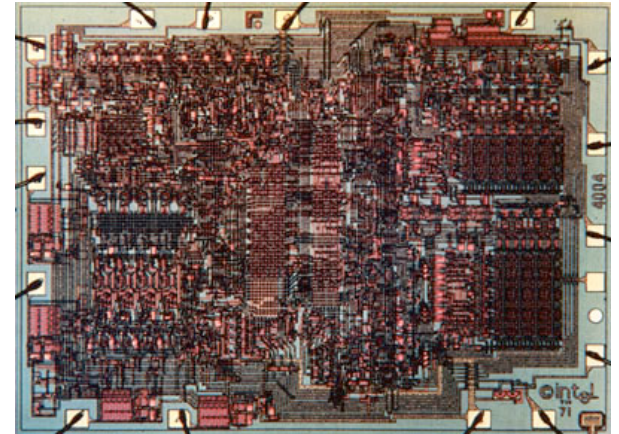
Die Micrograph and Key Data

Single Tile	
Transistors	325,000
Area	0.17 mm ²
CMOS Tech.	65 nm ST Microelectronics low-leakage
Max. frequency	1.19 GHz @ 1.3 V
Power (100% active)	59 mW @ 1.19 GHz, 1.3 V
	608 μ W @ 66 MHz, 0.675 V
App. power (802.11a rx)	16 mW @ 590 MHz, 1.3 V



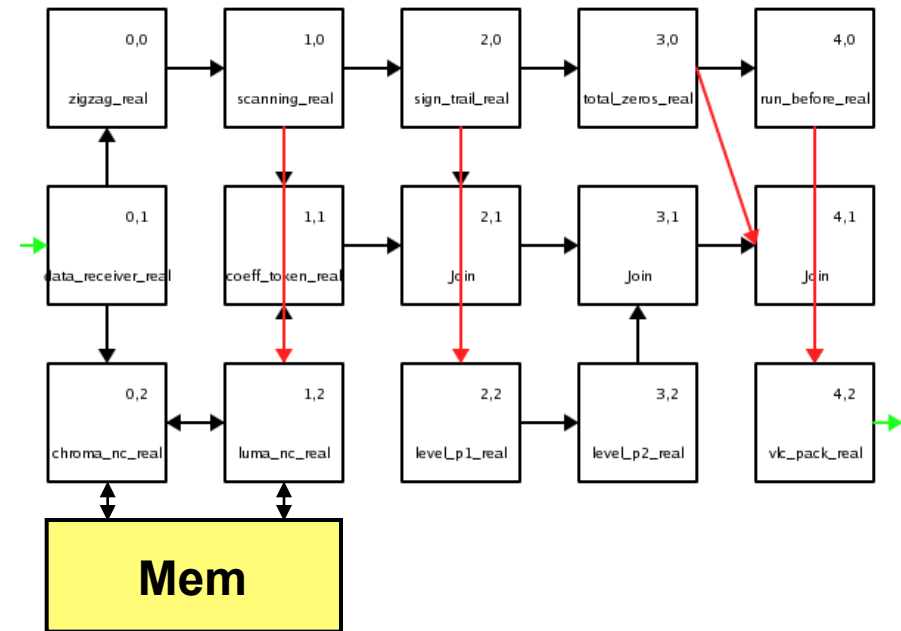
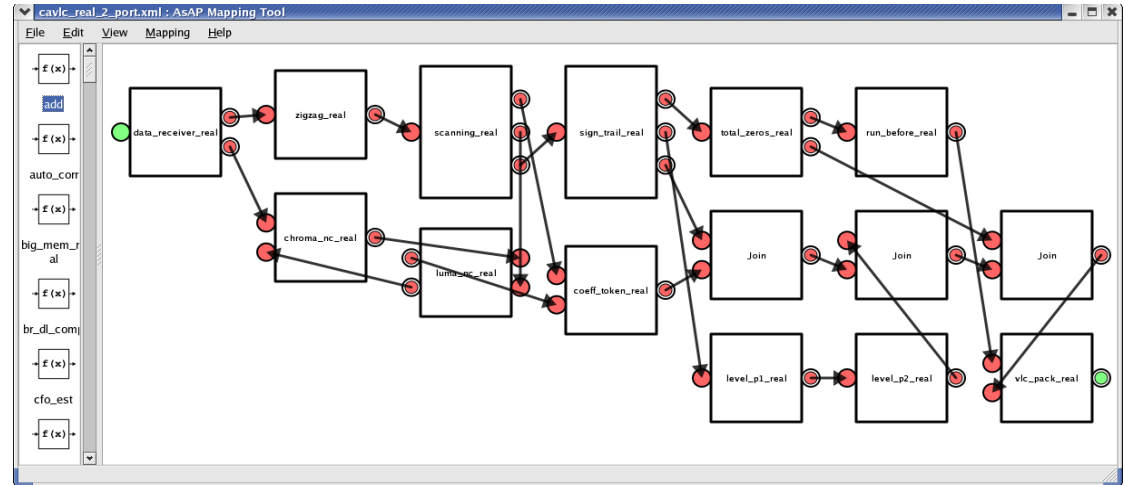
New Parallel Processing Paradigm

- Intel 4004 4-bit CPU, 1971
 - Utilized 2300 transistors
- The presented chip would have 2300 *processors* in 19.8mm x 19.8mm
- New parallel processing paradigm
 - Enabled by numerous efficient processors
 - Focus on simplified programming and access to large data sets
 - Much less focus on load balancing or “wasting” processors for things like memories or routing data



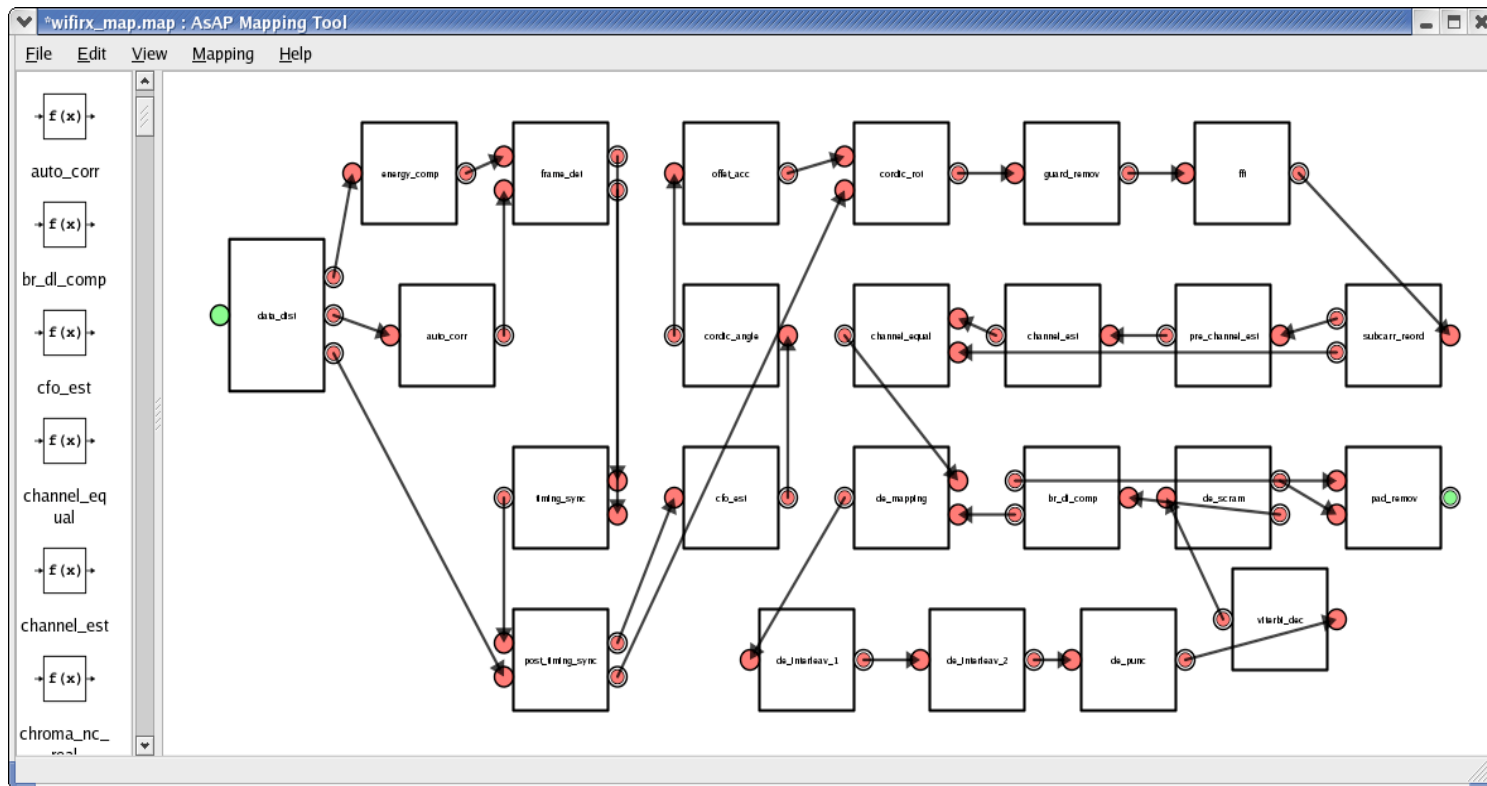
H.264 CAVLC Encoder

- Context-adaptive variable length coding (CAVLC) used in H.264 baseline encoder
- 15 processors with one shared memory
- 30fps 720p HDTV @ 1.07GHz
- ~1.0-6.15 times the throughput of TI C62x and ADSP BF561 (scaled to 65 nm, 1.3 V)



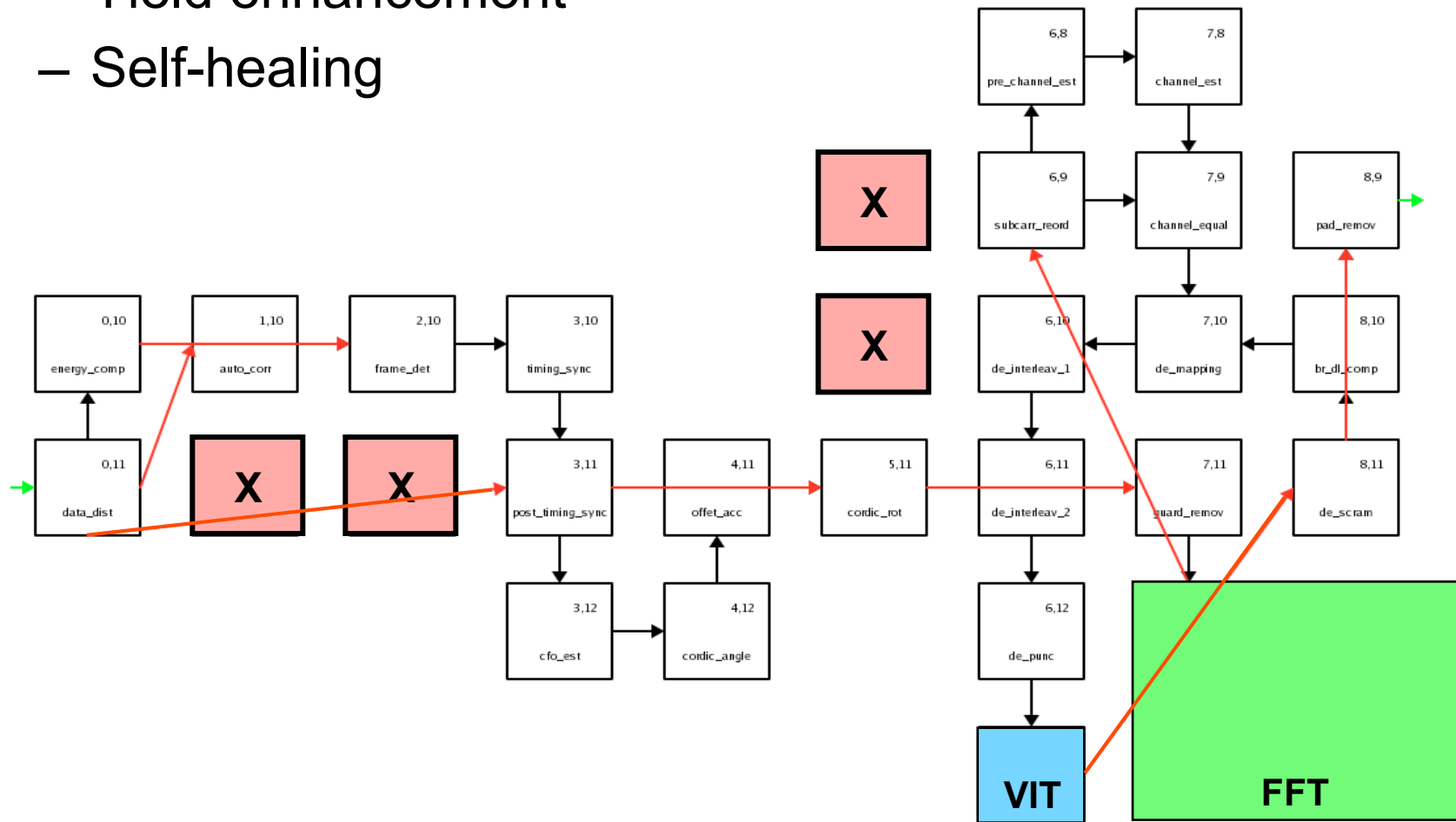
Complete 802.11a Baseband Receiver

- 22 processors plus Viterbi and FFT accelerators
- Includes: frame detection and synchronization, carrier-frequency offset estimation and compensation, channel equalization



Complete 802.11a Baseband Receiver

- Re-mapped graph avoids bad processors
 - Yield enhancement
 - Self-healing



Summary

- All processors and shared memories contain fully independent clock oscillators
- 164 homogenous processors
 - 1.2 GHz, 59 mW, 100% active @ 1.3 V
 - 608 μ W, 100% active @ 66 MHz, 0.675 V
- Three 16 KB shared memories
- Three dedicated-purpose processors
- Long-distance circuit-switched communication increases mapping efficiency with low overhead
- DVFS nets a 48% reduction in energy for JPEG application with an 8% performance loss

Acknowledgements

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